

30V N-Channel Enhancement Mode Power MOSFET

Description

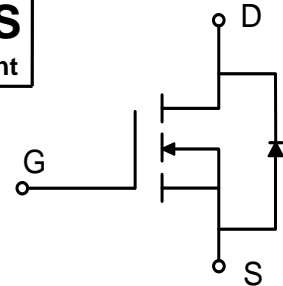
WMR16N03T1 uses advanced power trench technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Features

- $V_{DS} = 30V$, $I_D = 16A$
 $R_{DS(on)} < 5.2m\Omega @ V_{GS} = 10V$
 $R_{DS(on)} < 7.2m\Omega @ V_{GS} = 4.5V$
- Green Device Available
- Low $R_{DS(ON)}$
- Advanced High Cell Density Trench Technology



RoHS
compliant



Applications

- Battery Protection
- Power Management
- Load Switch

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current@10V ¹	I_D	$T_A=25^\circ C$	16
		$T_A=70^\circ C$	13.5
Pulsed Drain Current ²	I_{DM}	63	A
Single Pulse Avalanche Energy ³	EAS	61.2	mJ
Avalanche Current	I_{AS}	35	A
Total Power Dissipation ⁴	P_D	$T_A=25^\circ C$	3.1
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55 to+150

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ¹	$R_{\theta JA}$	47	$^\circ C/W$

Electrical Characteristics $T_c = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	30	-	-	V	
Gate-body Leakage current	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	± 100	nA	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 30V, V_{GS} = 0V$	$T_J = 25^\circ\text{C}$	-	-	1	μA
			$T_J = 125^\circ\text{C}$	-	-	10	
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.0	1.5	2.5	V	
Drain-Source On-Resistance ²	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 10A$	-	3.9	5.2	m Ω	
		$V_{GS} = 4.5V, I_D = 8A$	-	5.4	7.2		
Dynamic Characteristics							
Input Capacitance	C_{iss}	$V_{DS} = 15V, V_{GS} = 0V,$ $f = 1.0\text{ MHz}$	-	2390	-	pF	
Output Capacitance	C_{oss}		-	282	-		
Reverse Transfer Capacitance	C_{rss}		-	230	-		
Switching Characteristics							
Gate Resistance	R_g	$V_{DS} = 0V, V_{GS} = 0V,$ $f = 1.0\text{ MHz}$	-	3.2	-	Ω	
Total Gate Charge	Q_g	$V_{GS} = 4.5V, V_{DS} = 15V,$ $I_D = 12A$	-	10.2	-	nC	
Gate-Source Charge	Q_{gs}		-	4.5	-		
Gate-Drain Charge	Q_{gd}		-	3	-		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 4.5V, V_{DD} = 15V,$ $I_D = 10A, R_{GEN} = 5\Omega$	-	9.7	-	nS	
Rise Time	t_r		-	3.2	-		
Turn-Off Delay Time	$t_{d(off)}$		-	29.1	-		
Fall Time	t_f		-	6.2	-		
Drain-Source Body Diode Characteristics							
Diode Forward Voltage ²	V_{SD}	$I_S = 10A, V_{GS} = 0V$	-	0.8	1.2	V	
Reverse Recovery Time	t_{rr}	$I_F = 10A, di/dt = 100A/\mu s$	-	27.5	-	nS	
Reverse Recovery Charge	Q_{rr}		-	15	-	nC	

Notes:

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper
2. The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. The EAS data shows Max. rating. The test condition is $V_{DD} = 25V, V_{GS} = 10V, L = 0.1\text{ mH}, I_{AS} = 35A$
4. The power dissipation is limited by 150°C junction temperature
5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation

Figure 1. Output Characteristics

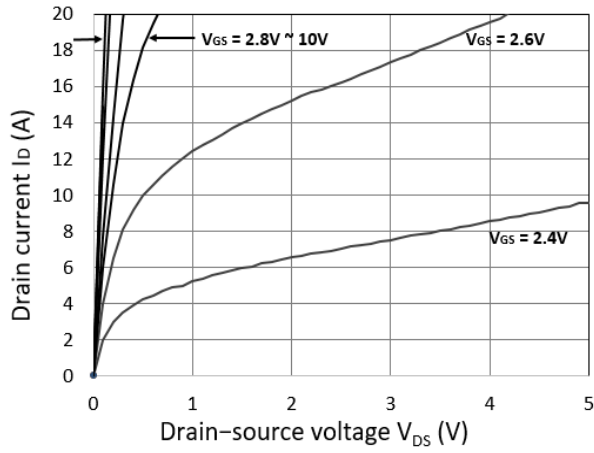


Figure 2. Transfer Characteristic

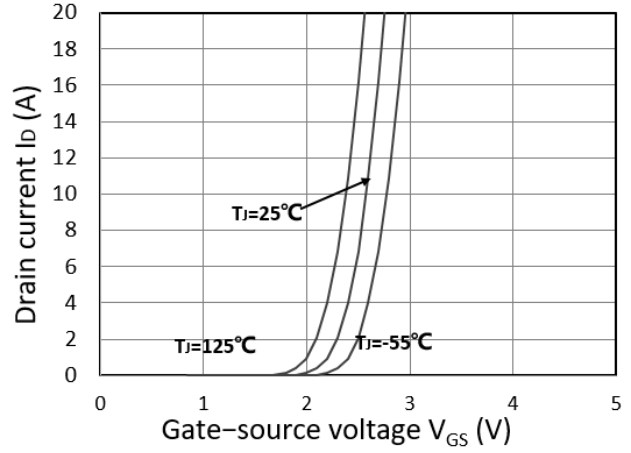


Figure 3. Capacitance Characteristics

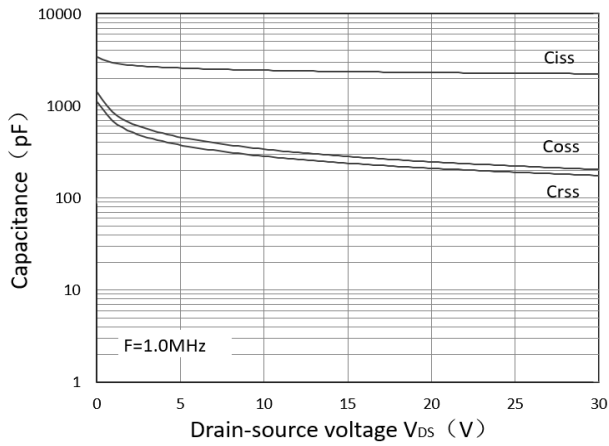


Figure 4. Gate Charge Characteristics

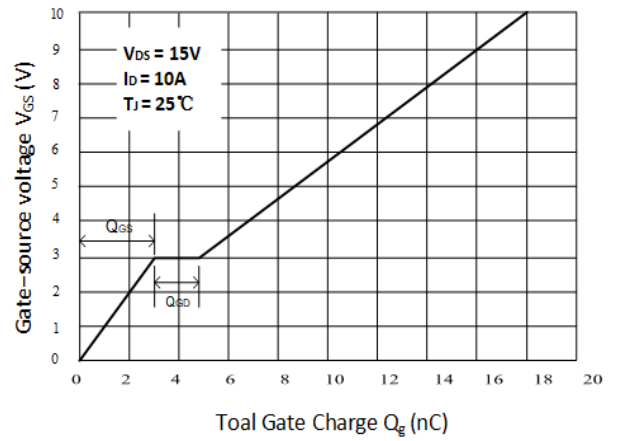


Figure 5. $R_{DS(ON)}$ vs. I_D

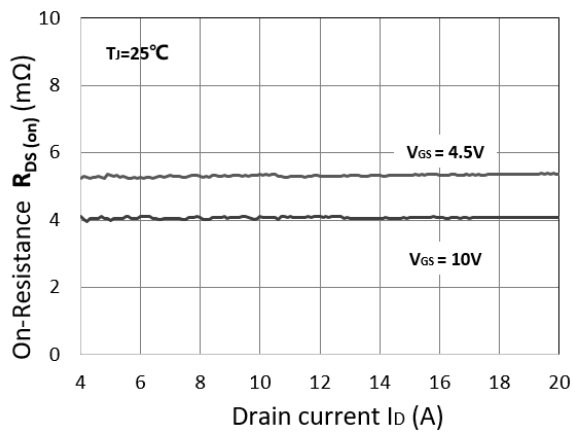


Figure 6. Normalized $R_{DS(on)}$ vs. T_J

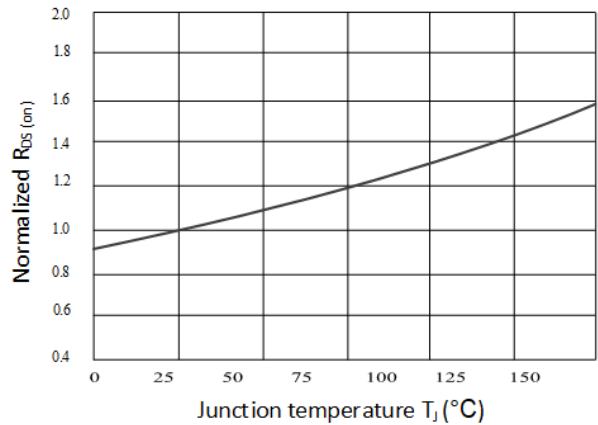


Figure 7. $R_{DS(on)}$ vs. V_{GS}

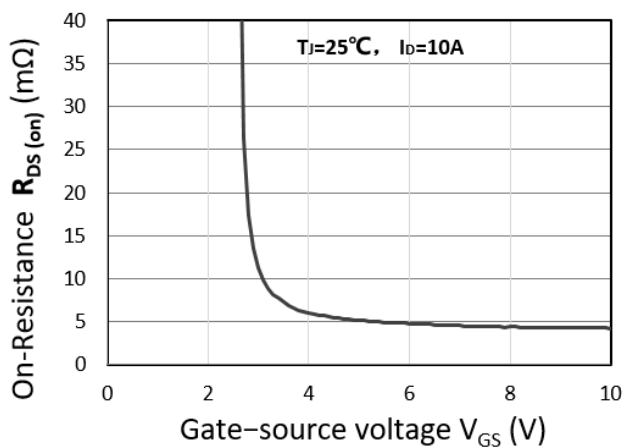


Figure 9. Switching Time Waveform

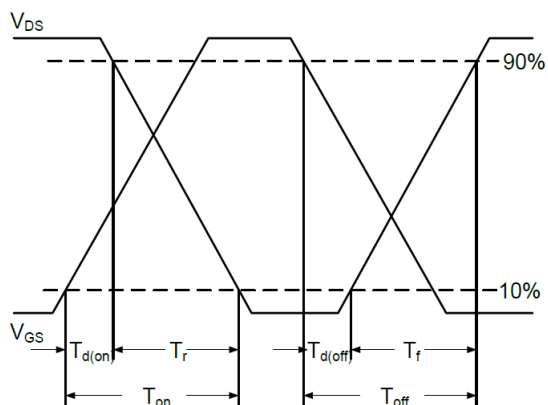


Figure 8. Forward Characteristics of Reverse

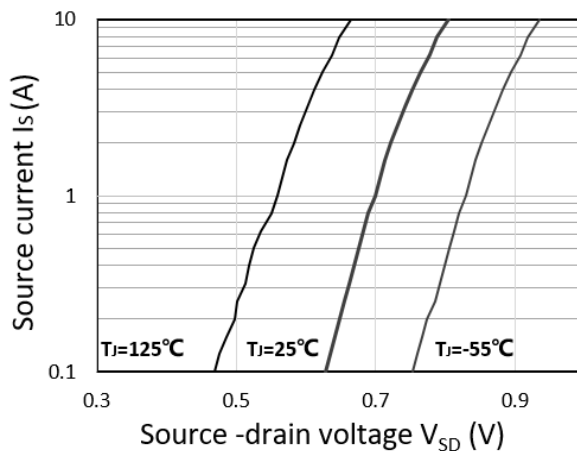
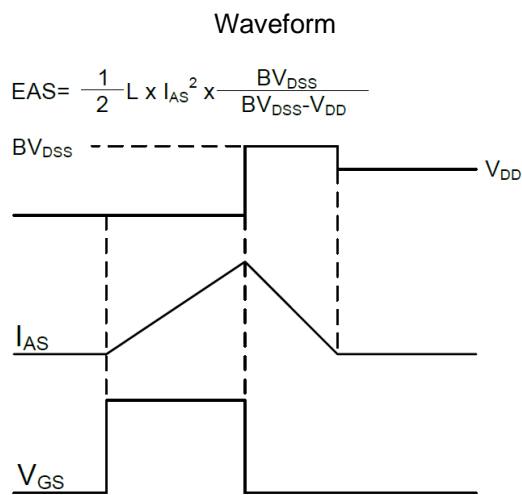
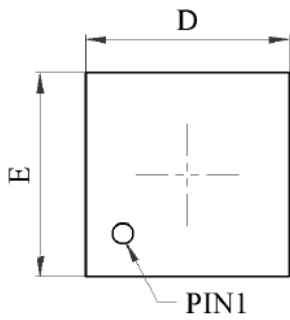


Figure 10. Unclamped Inductive Switching

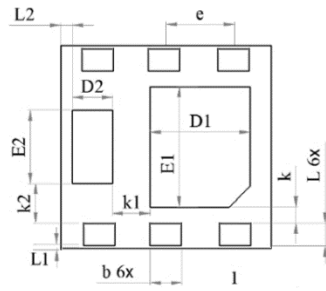


Mechanical Dimensions for DFN2020-6L

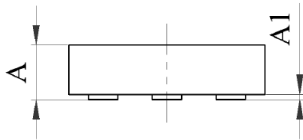
COMMON DIMENSIONS



TOP VIEW



BOTTOM VIEW



SIDE VIEW

SYMBOL	MM	
	MIN	MAX
A	0.500	0.600
A1	0.025	0.075
D	1.900	2.100
E	1.900	2.100
D1	0.850	1.050
E1	1.050	1.250
D2	0.330	0.430
E2	0.650	0.750
b	0.250	0.350
L	0.195	0.295
L1	0.030REF	
L2	0.110REF	
k	0.150REF	
k1	0.360REF	
k2	0.375REF	
e	0.650REF	

Ordering Information

Part	Package	Marking	Packing method
WMR16N03T1	DFN2020-6L	R16N03	Tape and Reel

Marking Information



R16N03 = Device code

WWXX XXX= Date code

Contact Information

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